

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. - 7. (canceled).

8. (currently amended): A method of manufacturing an instrument panel mounted on a vehicle, comprising the steps of:

providing a substrate;

depositing an ink permeative layer so as to cover at least one of an obverse face and a reverse face of the substrate, the ink permeative layer being made of a heat-resistant material containing 20 to 80% of at least one of urethane resin and polyester resin;

providing digital print data according to a design of the instrument panel including at least one of indicative scales, indicative numerals, indicative characters and indicative symbols on the instrument panel which are visually presented to a driver; and

jetting ink to the ink permeative layer in accordance with the digital print data.

9. (original): The manufacturing method as set forth in claim 8, further comprising the step of determining the design of the instrument panel according to a request of the driver.

10. (new): The manufacturing method as set forth in claim 8, further comprising the step of providing an adhesive layer between the substrate and the ink permeative layer.

11. (new): A method of manufacturing an instrument panel mounted on a vehicle, comprising the steps of:

providing a substrate;

depositing a first ink permeative layer over a first face of the substrate;

depositing a second ink permeative layer over a second face of the substrate;

providing print data according to a design of the instrument panel including at least a symbol;

jetting ink to the first ink permeative layer to form a shape of the symbol; and

jetting ink to the second ink permeative layer to exclude an area corresponding to the shape of the symbol.

12. (new): The manufacturing method as set forth in claim 11, further comprising the step of providing an adhesive layer between the substrate and one of the first and second ink permeative layers.

13. (new): The manufacturing method as set forth in claim 11, wherein the substrate is transparent.

14. (new): The manufacturing method as set forth in claim 11, wherein the print data is provided in the form of digital print data.